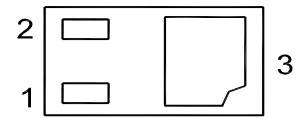


MMBT3906HP

PNP Silicon General Purpose Transistor

for switching and amplifier applications.



Bottom view
1. Base 2. Emitter 3. Collector
DFN1006-3H Plastic Package

Absolute Maximum Ratings ($T_a = 25^\circ\text{C}$)

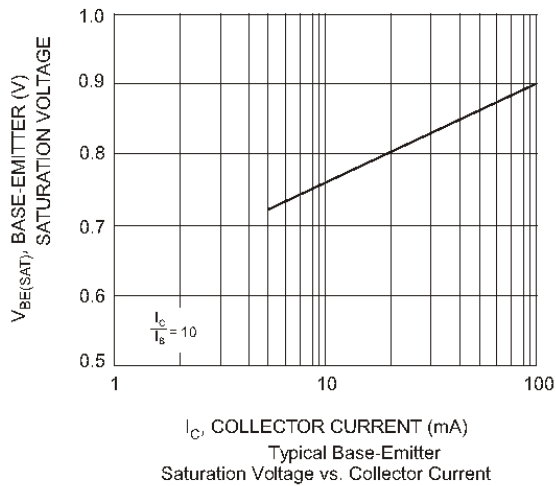
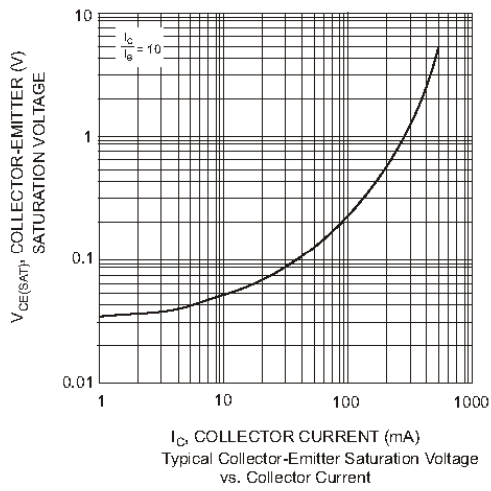
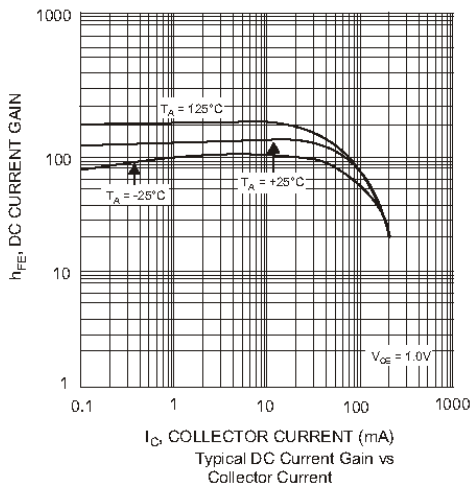
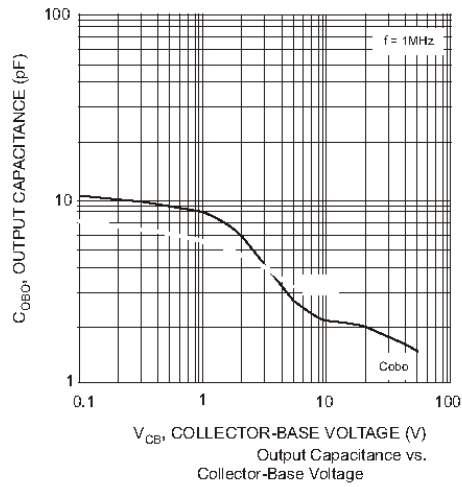
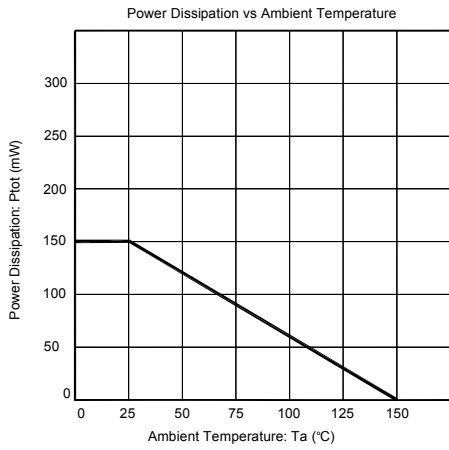
Parameter	Symbol	Value	Unit
Collector Base Voltage	$-V_{CBO}$	40	V
Collector Emitter Voltage	$-V_{CEO}$	40	V
Emitter Base Voltage	$-V_{EBO}$	6	V
Collector Current	$-I_C$	200	mA
Power Dissipation	P_{tot}	100	mW
Junction Temperature	T_j	150	$^\circ\text{C}$
Storage Temperature Range	T_{stg}	- 55 to + 150	$^\circ\text{C}$

Characteristics at $T_a = 25^\circ\text{C}$

Parameter	Symbol	Min.	Max.	Unit
DC Current Gain				
at $-V_{CE} = 1\text{ V}$, $-I_C = 0.1\text{ mA}$	h_{FE}	60	-	-
at $-V_{CE} = 1\text{ V}$, $-I_C = 1\text{ mA}$	h_{FE}	80	-	-
at $-V_{CE} = 1\text{ V}$, $-I_C = 10\text{ mA}$	h_{FE}	100	300	-
at $-V_{CE} = 1\text{ V}$, $-I_C = 50\text{ mA}$	h_{FE}	60	-	-
at $-V_{CE} = 1\text{ V}$, $-I_C = 100\text{ mA}$	h_{FE}	30	-	-
Collector Base Cutoff Current at $-V_{CB} = 30\text{ V}$	$-I_{CBO}$	-	50	nA
Emitter Base Cutoff Current at $-V_{EB} = 6\text{ V}$	$-I_{EBO}$	-	50	nA
Collector Base Breakdown Voltage at $-I_C = 10\ \mu\text{A}$	$-V_{(BR)CBO}$	40	-	V
Collector Emitter Breakdown Voltage at $-I_C = 1\text{ mA}$	$-V_{(BR)CEO}$	40	-	V
Emitter Base Breakdown Voltage at $-I_E = 10\ \mu\text{A}$	$-V_{(BR)EBO}$	6	-	V
Collector Emitter Saturation Voltage at $-I_C = 10\text{ mA}$, $-I_B = 1\text{ mA}$ at $-I_C = 50\text{ mA}$, $-I_B = 5\text{ mA}$	$-V_{CE(sat)}$	-	0.25 0.4	V
Base Emitter Saturation Voltage at $-I_C = 10\text{ mA}$, $-I_B = 1\text{ mA}$ at $-I_C = 50\text{ mA}$, $-I_B = 5\text{ mA}$	$-V_{BE(sat)}$	0.65 -	0.85 0.95	V
Current Gain Bandwidth Product at $-V_{CE} = 20\text{ V}$, $-I_C = 10\text{ mA}$, $f = 100\text{ MHz}$	f_T	250	-	MHz
Output Capacitance at $-V_{CB} = 5\text{ V}$, $I_E = 0$, $f = 1\text{ MHz}$	C_{obo}	-	4.5	pF
Delay Time at $-V_{CC} = 3\text{ V}$, $-V_{BE} = 0.5\text{ V}$, $-I_C = 10\text{ mA}$, $-I_{B1} = 1\text{ mA}$	t_d	-	35	ns
Rise Time at $-V_{CC} = 3\text{ V}$, $-V_{BE} = 0.5\text{ V}$, $-I_C = 10\text{ mA}$, $-I_{B1} = 1\text{ mA}$	t_r	-	35	ns
Storage Time at $-V_{CC} = 3\text{ V}$, $-I_C = 10\text{ mA}$, $-I_{B1} = I_{B2} = 1\text{ mA}$	t_s	-	225	ns
Fall Time at $-V_{CC} = 3\text{ V}$, $-I_C = 10\text{ mA}$, $-I_{B1} = I_{B2} = 1\text{ mA}$	t_f	-	75	ns

TOP DYNAMIC

MMBT3906HP



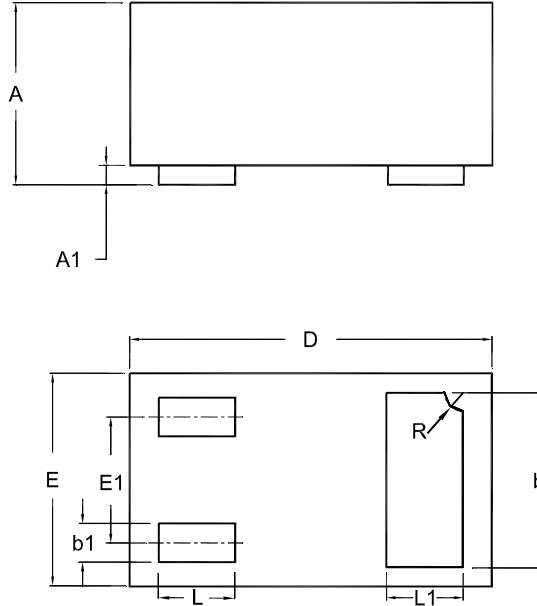
TOP DYNAMIC

MMBT3906HP

PACKAGE OUTLINE

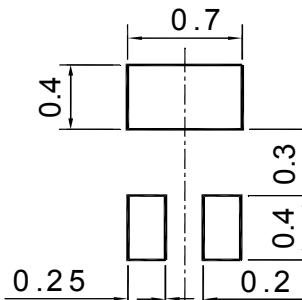
Plastic surface mounted package

DFN1006-3H



UNIT	A	A1	b	b1	D	E	E1	L	L1	R
mm	0.51	0.05	0.55	0.2	1.05	0.65	0.325	0.3	0.3	0.15
	0.46	0	0.45	0.1	0.95	0.55		0.2	0.2	0.05

Recommended Soldering Footprint



Packing information

Package	Tape Width (mm)	Pitch		Reel Size		Per Reel Packing Quantity
		mm	inch	mm	inch	
DFN1006-3H	8	4 ± 0.1	0.157 ± 0.004	178	7	5,000

TOP DYNAMIC